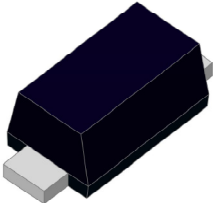


1.0 Amp. Surface Mount Top Glass Passivated Ultrafast Very Soft Recovery Rectifier

SOD123W		Voltage 200 V	Current 1.0 A
		FEATURE <ul style="list-style-type: none"> • Top-Glass Technology • Low profile package • Ideal for automated placement • Low power losses, high efficiency • High surge current capability • Cavity-free glass-passivated junction • Low forward voltage drop • Solder dip 260 °C, 10s • AEC-Q101 qualified • Component in accordance to RoHS 2011/65/EU and WEEE 2002/96/EC • Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C • Very soft recovery characteristics • Significantly reduced EMI. Very low noise. 	
		MECHANICAL DATA <ul style="list-style-type: none"> • Case: SOD123W. Epoxy meets UL 94V-0 flammability rating. • Polarity: Color band denotes cathode end. • Terminals: Matte tin plated leads, solderable per MIL-STD-750 Method 2026, J-STD-002 and JESD22-B102. Consumer grade, meets JESD 201 class 1A whisker test. • HE3 suffix for high reliability grade, meets JESD 201 class 2 whisker test. 	
		TYPICAL APPLICATIONS Used in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive and telecommunication.	

 AUTOMOTIVE
GRADE
Available

 RoHS
COMPLIANT

Maximun Ratings and Electrical Characteristics at 25 °C

Marking Code		FES1DWSR TG
		WF
V_{RRM}	Maximum Recurrent Peak Reverse Voltage (V)	200
V_{RMS}	Maximum RMS Voltage (V)	140
V_{DC}	Maximum DC Blocking Voltage (V)	200
$I_{F(VA)}$	Maximum Average Forward Rectified Current at $T_L = 110$	1.0 A
I_{FSM}	Peak Forward Surge Current, 8.3 ms. Single Half Si- ne-Wave Superimposed on Rated Load (Jedec Method)	50 A
V_F	Maximum Instantaneous Forward	$T_j = 25\text{ °C}$ 0.90 V
	Voltaje @ 1 A	$T_j = 125\text{ °C}$ 0.76 V
I_R	Maximum DC Reverse Leakage Current. $V_R = V_{RRM}$	$T_j = 25\text{ °C}$ 2 μ A
		$T_j = 125\text{ °C}$ 8 μ A
		$T_j = 175\text{ °C}$ 40 μ A
C_j	Typical Junction Capacitance (1 MHz; -4.0V)	15 pF
$R_{th(j-c)}$	Maximum Thermal Resistance Junction to Case	17 °C/W
$R_{th(j-a)}$	Maximum Thermal Resistance Junction to Ambient:	
	. FR4 PCB Standard Footprint	217 °C/W
	. FR4 PCB Mounting Pad for Cathode 1 cm ²	126 °C/W
$T_j - T_{stg}$	Operating Junction and Storage Temperature Range	-65 to +175 °C

1.0 Amp. Surface Mount Top Glass Passivated Ultrafast Very Soft Recovery Rectifier
Recovery Characteristics ($T_j = 25\text{ °C}$)

Symbol	Test Conditions	Min.	Max	Typ.	Unit
trr	$I_F = 0.5\text{ A}$, $dI_F/dt = 100\text{ A}/\mu\text{s}$, I_R limited to 1000 mA		25		ns
ta				15	
tb				6	
tb/ta	Softness	0.45			
Qrr	VR= 30v, $dI_F/dt = 50\text{ A}/\mu\text{s}$, $I_F = 1\text{ A}$			7	nC
	VR= 30v, $dI_F/dt = 50\text{ A}/\mu\text{s}$, $I_F = 2\text{ A}$			8.5	
	VR= 30v, $dI_F/dt = 50\text{ A}/\mu\text{s}$, $I_F = 5\text{ A}$			9.5	
	VR= 30v, $dI_F/dt = 50\text{ A}/\mu\text{s}$, $I_F = 15\text{ A}$			10	
Qrr	VR= 30v, $dI_F/dt = 150\text{ A}/\mu\text{s}$, $I_F = 1\text{ A}$			9	nC
	VR= 30v, $dI_F/dt = 150\text{ A}/\mu\text{s}$, $I_F = 2\text{ A}$			15	
	VR= 30v, $dI_F/dt = 150\text{ A}/\mu\text{s}$, $I_F = 5\text{ A}$			25	
	VR= 30v, $dI_F/dt = 150\text{ A}/\mu\text{s}$, $I_F = 15\text{ A}$			30	

Static Characteristics

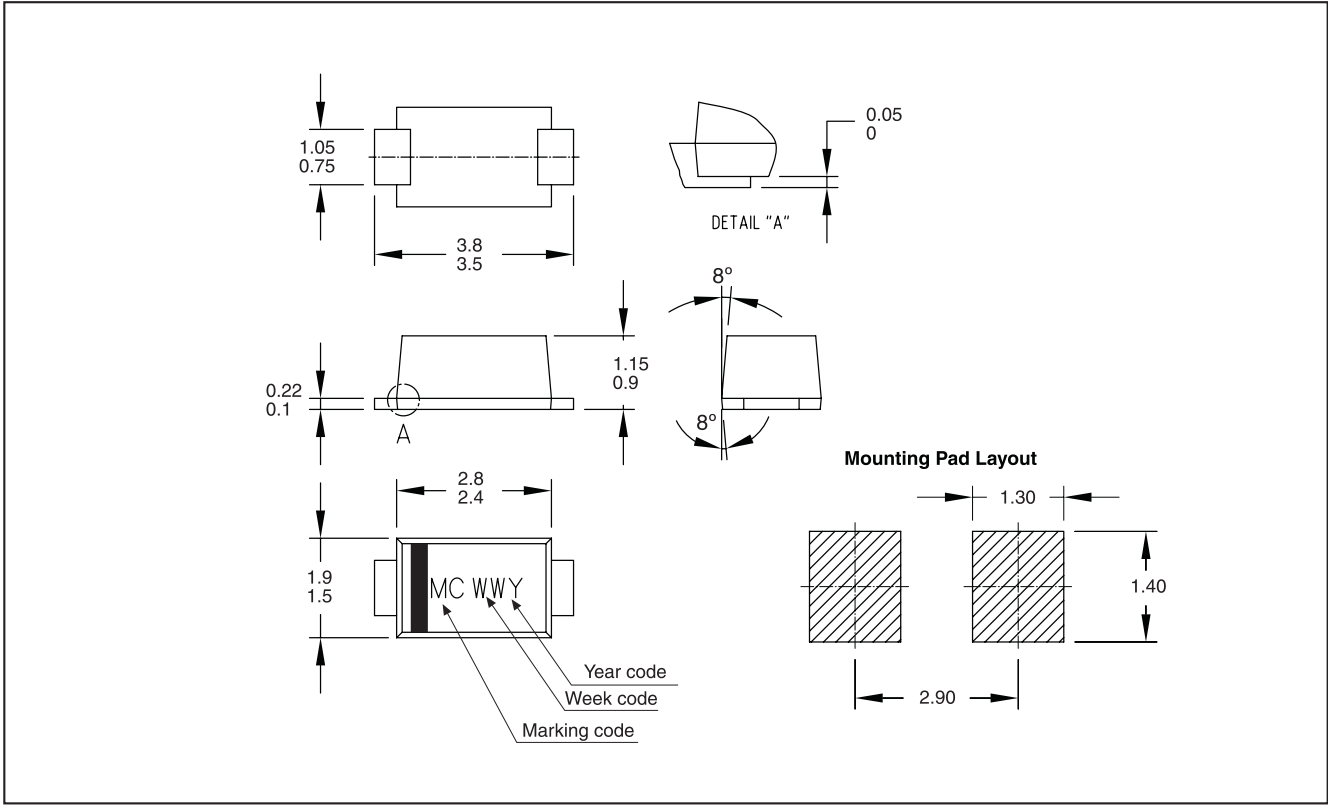
PARAMETER		UNIT	$T_j = -40\text{ °C}$	$T_j = 0\text{ °C}$	$T_j = 25\text{ °C}$	$T_j = 125\text{ °C}$	$T_j = 150\text{ °C}$	$T_j = 175\text{ °C}$
I_R at $V_R = 30\text{ V}$	max.	μA	<0.001	<0.001	<0.001	1	7	25
I_R at $V_R = 100\text{ V}$	max.		<0.001	0.05	0.1	1.3	9	30
I_R at $V_R = 200\text{ V}$	max.		0.1	0.5	2	8	11	40
V_F at $I_F = 0.5\text{ A}$	max.	V	0.95	0.86	0.82	0.67	0.64	0.61
V_F at $I_F = 1\text{ A}$	max.		1	0.94	0.90	0.76	0.70	0.67

1.0 Amp. Surface Mount Top Glass Passivated Ultrafast Very Soft Recovery Rectifier

Ordering information

PREFERRED P/N	PACKAGE CODE	DELIVERY MODE	BASE QUANTITY	UNIT WEIGHT (g)
FES1DWSR TG TRTB	TRTB	13" diameter tape and reel	10,000	0.0165
FES1DWSR TG HE3 TRTB	TRTB	13" diameter tape and reel	10,000	0.0165

Package Outline Dimensions: (mm) SOD123W



1.0 Amp. Surface Mount Top Glass Passivated Ultrafast Very Soft Recovery Rectifier

Fig. 1 REVERSE CURRENT vs REVERSE VOLTAGE

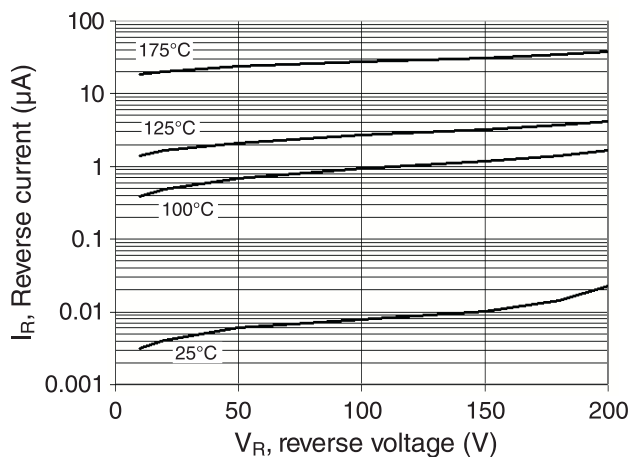


Fig. 2 FORWARD VOLTAGE vs FORWARD CURRENT

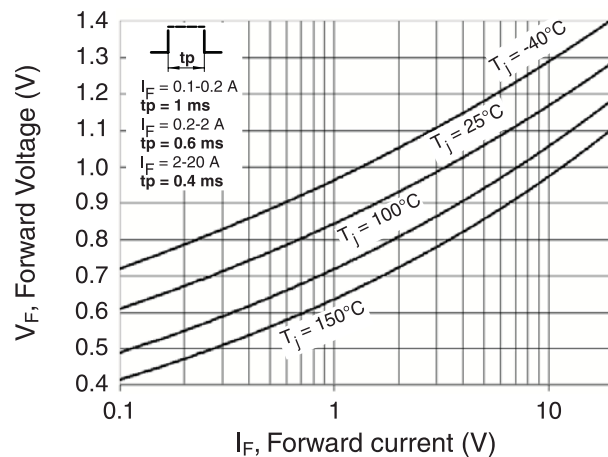


Fig. 3 LOW FREQUENCY POWER LOSSES vs. AVERAGE CURRENT

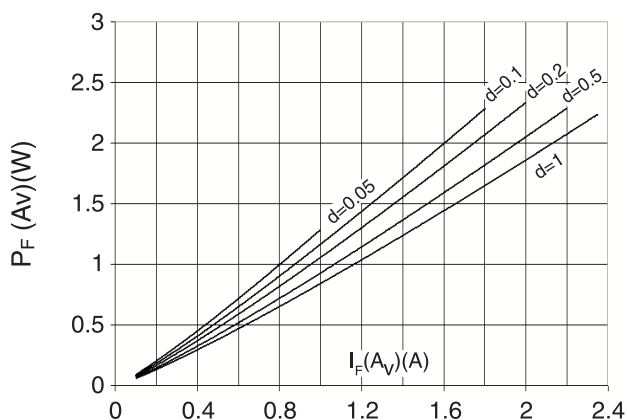


Fig. 4 PEAK CURRENT vs. FORM FACTOR

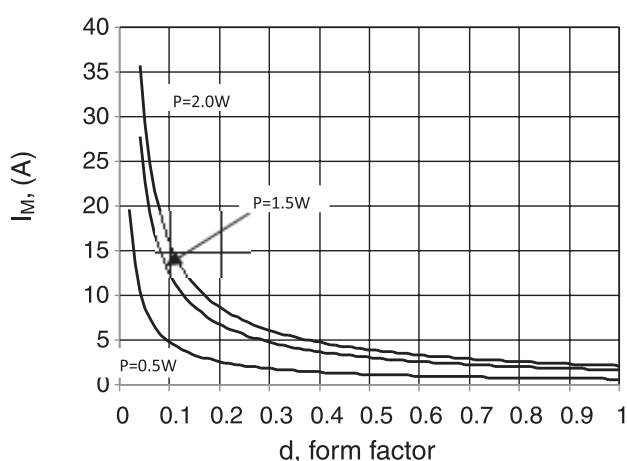


Fig. 5 FORWARD CURRENT DERATING CURVE

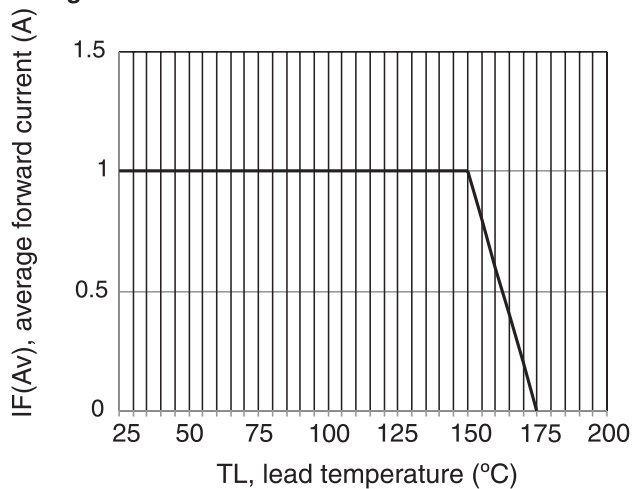
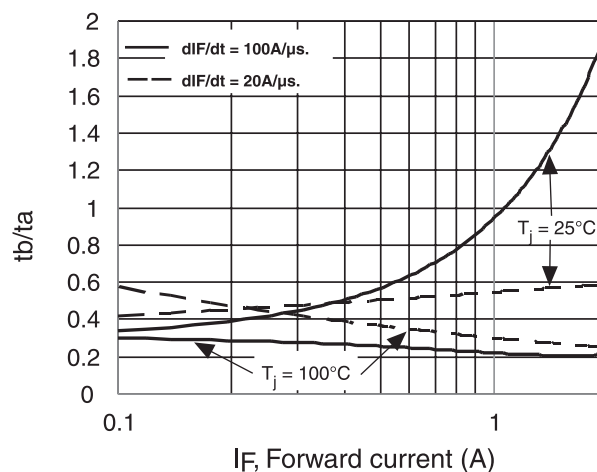


Fig. 6 t_b/t_a CURVES vs. FORWARD CURRENT



1.0 Amp. Surface Mount Top Glass Passivated Ultrafast Very Soft Recovery Rectifier

Fig. 7 t_{rr} , t_a AND t_b CURVES vs FORWARD CURRENT.
 $T_c = 25^\circ\text{C}$

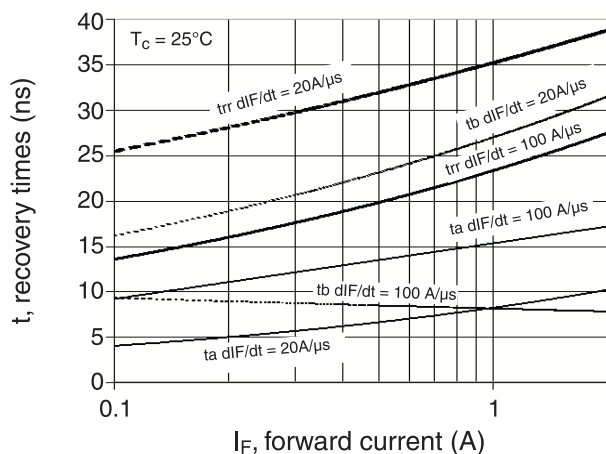


Fig. 8 t_{rr} , t_a AND t_b CURVES vs FORWARD CURRENT.
 $T_c = 100^\circ\text{C}$

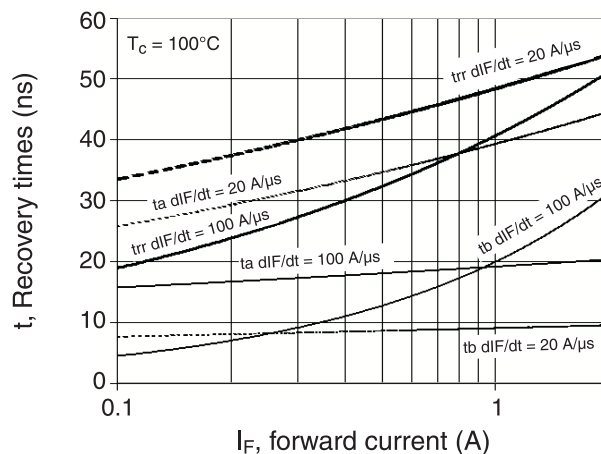


Fig. 9 RECOVERY TIME vs dI_F/dt

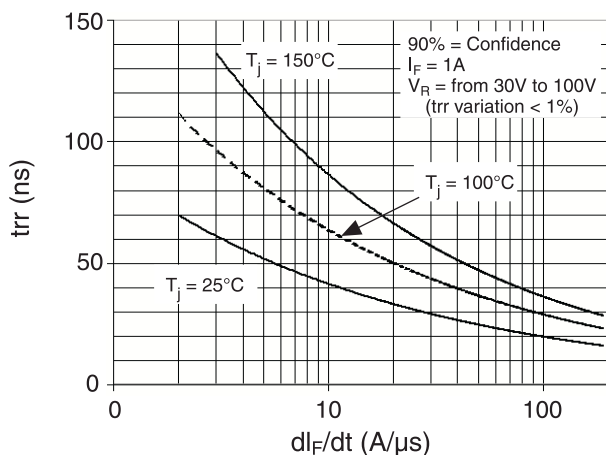


Fig. 10 PEAK REVERSE CURRENT vs dI_F/dt

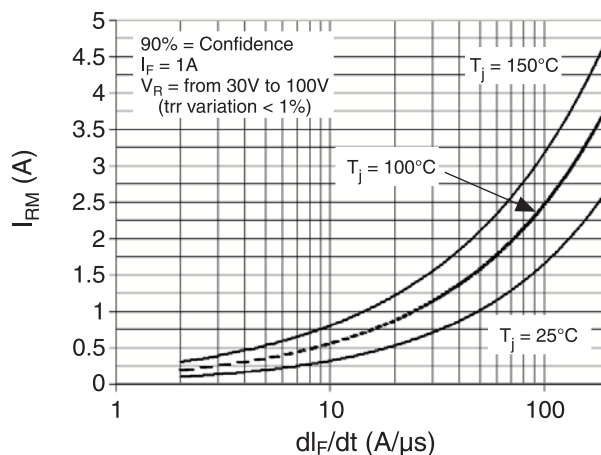


Fig. 11 t_{rr} vs dI_F/dt . $I_F = 2\text{ A}$

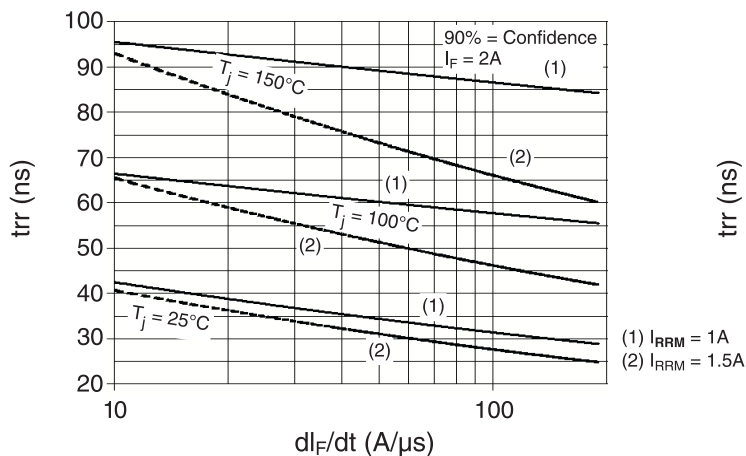
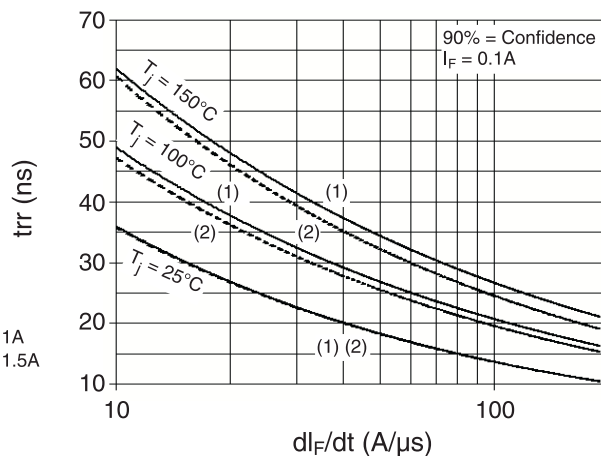
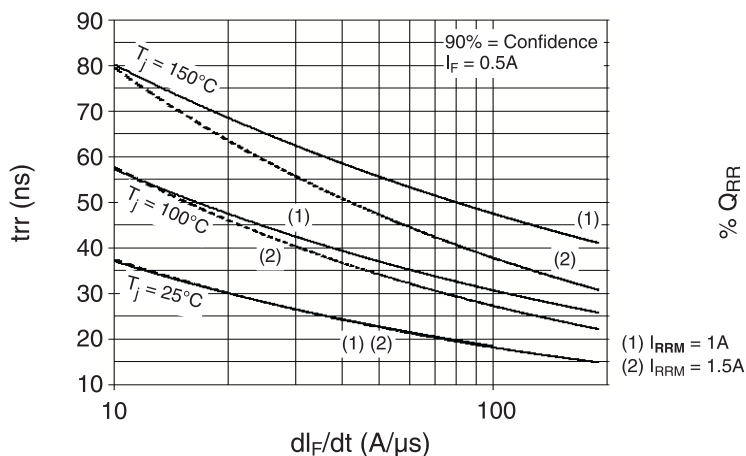
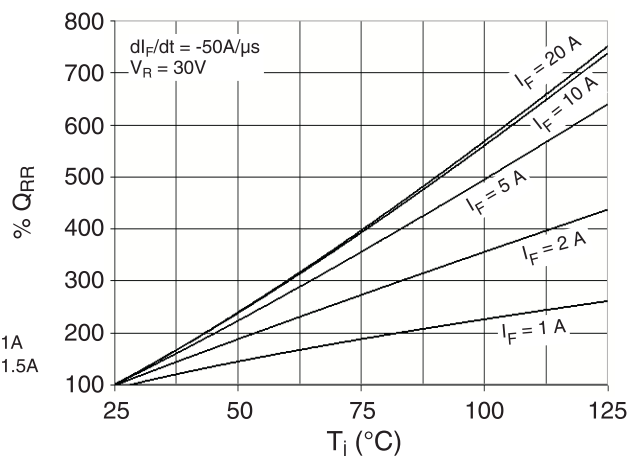
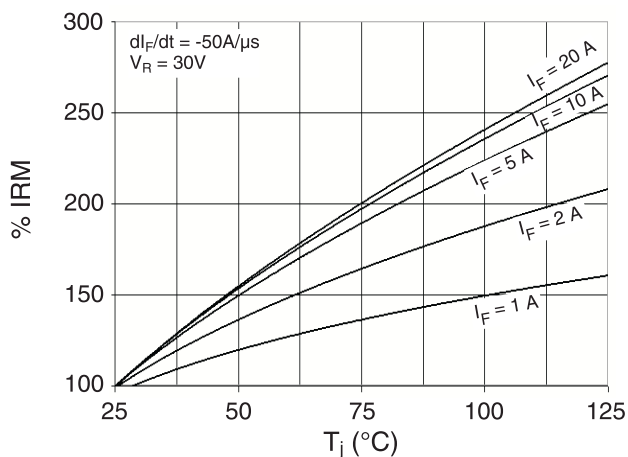
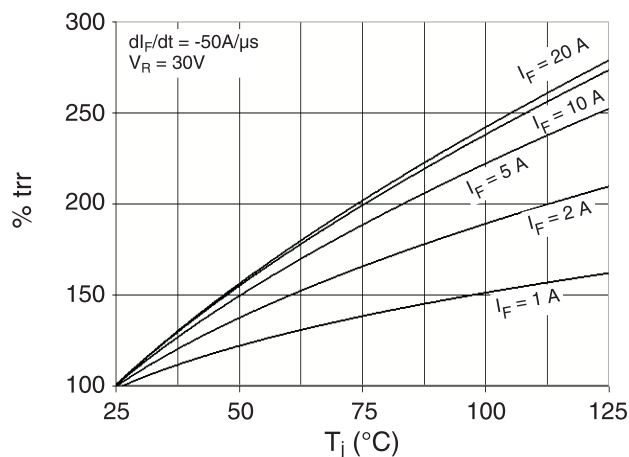
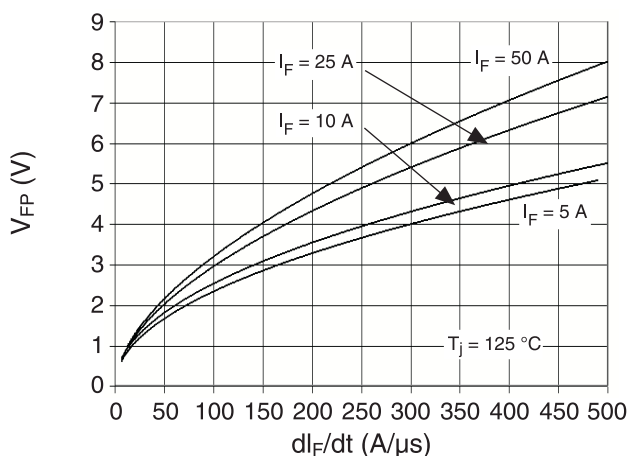
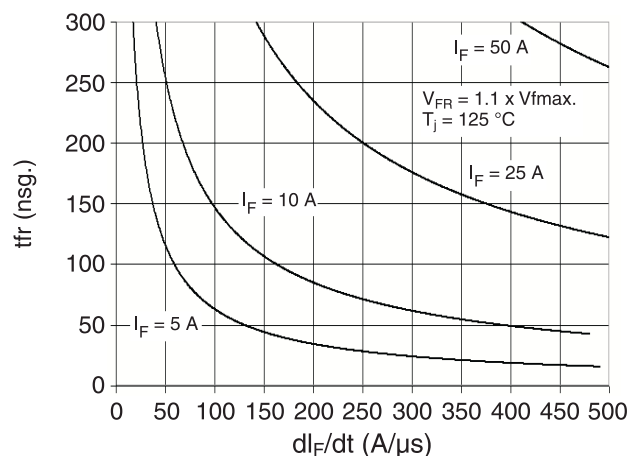


Fig. 12 t_{rr} vs dI_F/dt . $I_F = 0.1\text{ A}$



1.0 Amp. Surface Mount Top Glass Passivated Ultrafast Very Soft Recovery Rectifier
Fig. 13 trr vs di_F/dt . $I_F = 0.5$ A

Fig. 14 QRR vs JUNCTION TEMPERATURE

Fig. 15 IRM vs JUNCTION TEMPERATURE

Fig. 16 trr vs JUNCTION TEMPERATURE

Fig. 17 TRANSIENT PEAK FORWARD VOLTAGE vs di_F/dt

Fig. 18 FORWARD RECOVERY TIME vs di_F/dt


1.0 Amp. Surface Mount Top Glass Passivated Ultrafast Very Soft Recovery Rectifier

Fig. 19 RECOVERY TIME vs JUNCTION TEMPERATURE

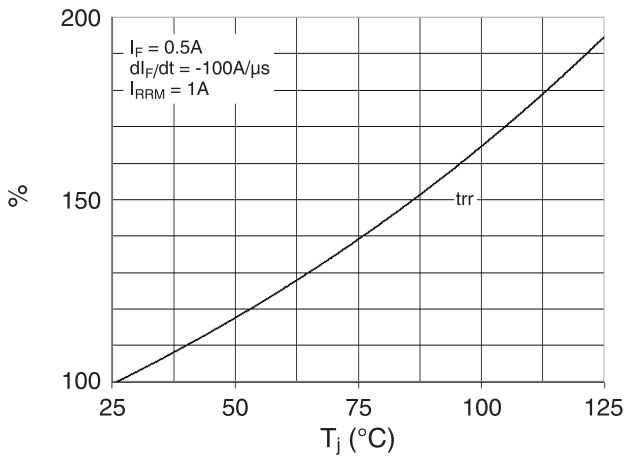
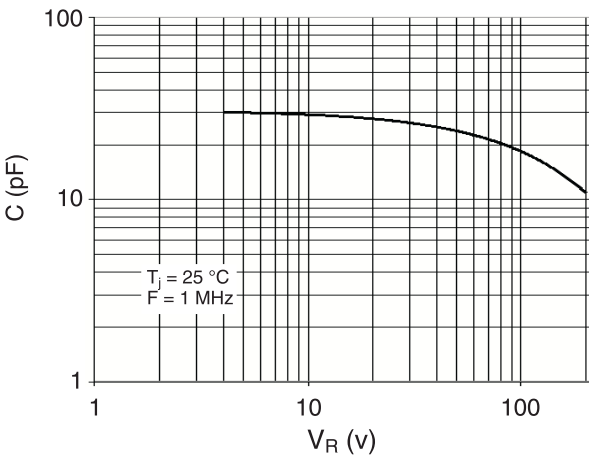
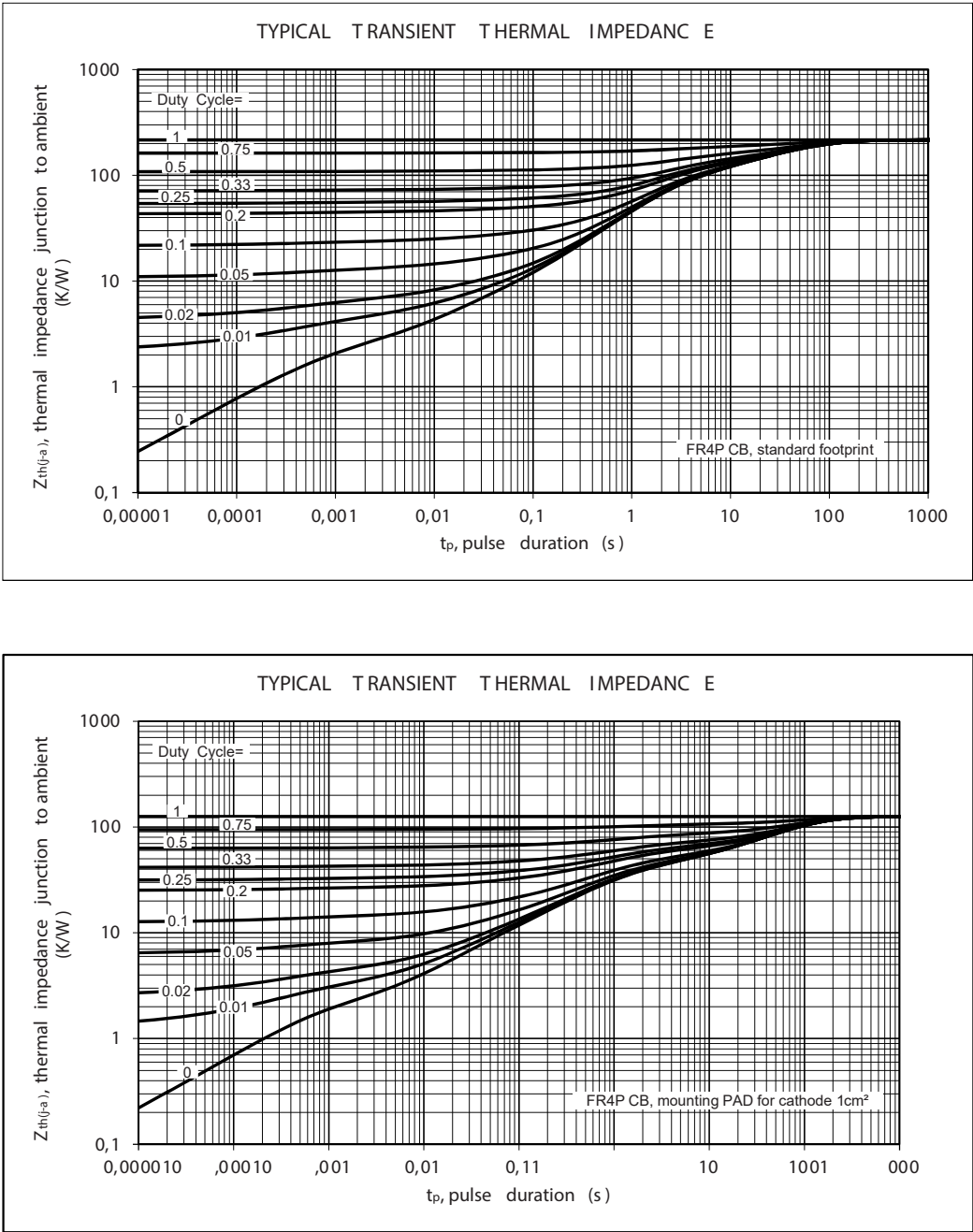


Fig. 20 JUNCTION CAPACITANCE vs. REVERSE BIAS



1.0 Amp. Surface Mount Top Glass Passivated Ultrafast Very Soft Recovery Rectifier

Fig. 21 RELATIVE VARIATION OF THERMAL IMPEDANCE TO AMBIENT vs. PULSE DURATION



1.0 Amp. Surface Mount Top Glass Passivated Ultrafast Very Soft Recovery Rectifier**Revision History**

DATE	REVISION	DESCRIPTION OF CHANGES
14-Jan-2013	0	Original Data Sheet
04-Dec-2015	1	Static Characteristics table added
05-Jan-2018	2	Thermal Impedance and graph revised
27-Oct-2020	3	Thermal Resistance Junction to Case included
23-Feb-2021	4	Correct the definition of IR used in the Test Condition for trr, ta and tb

Disclaimer

All product, product specifications and data are subject to change without notice to improve reliability, function or design or otherwise.

Fagor Electrónica, S. Coop., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Fagor"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Fagor makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Fagor disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Fagor's knowledge of typical requirements that are often placed on Fagor products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Fagor's terms and conditions or purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Fagor products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Fagor product could result in personal injury or death. Customers using or selling Fagor products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Fagor and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Fagor or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Fagor personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Fagor. Products names and markings noted herein may be trademarks of their respective owners.